

FEATURES

- Available as "HR" (high reliability) screened per MIL-PRF-19500, JANTX level. Add "HR" suffix to base part number.
- Available as non-RoHS (Sn/Pb plating), standard, and as RoHS by adding "-PBF" suffix.

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Repetitive peak off-stage voltage ($T_C = 110^\circ\text{C}$)			
SC136B	V_{DRM}	200	Volts
SC136C		300	
SC136D		400	
SC136E		500	
SC136M		600	
RMS on-state current ($T_C = 65^\circ\text{C}$)		$I_{\text{T(RMS)}}$	
Peak non-repetitive surge current (One Cycle, 60Hz)	I_{TSM}	30	Amps
Circuit fusing considerations ($t = 1\text{ms to } 8.3\text{ms}$)	I^2t	3.6	A^2s
Circuit rate of rise of on-state current	di/dt	5.0	$\text{A}/\mu\text{s}$
Peak gate power	P_{GM}	5.0	Watts
Average gate power	$P_{\text{G(AV)}}$	0.1	Watts
Peak gate voltage	V_{GM}	5.0	Volts
Operating junction temperature range	T_J	-40 to +110	$^\circ\text{C}$
Storage temperature range	T_{stg}	-40 to +150	$^\circ\text{C}$

THERMAL CHARACTERISTICS

Characteristics	Symbol	Max	Unit
Thermal resistance, junction to case	$R_{\theta\text{JC}}$	10	$^\circ\text{C}/\text{W}$
Thermal resistance, junction to ambient	$R_{\theta\text{JA}}$	75	$^\circ\text{C}/\text{W}$

ELECTRICAL CHARACTERISTICS ($T_C = 25^\circ\text{C}$ and either polarity of MT2 to MT1 voltage, unless otherwise noted)

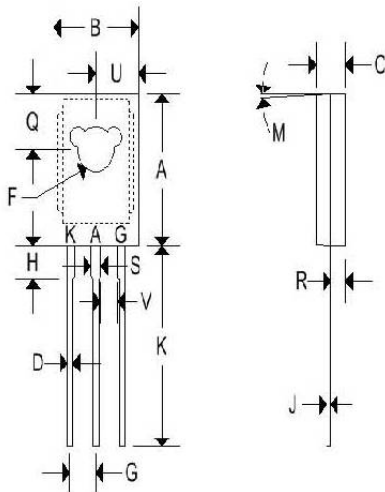
Characteristic	Symbol	Min	Typ	Max	Unit
Peak off state current (Rated V_{DRM} or V_{RRM} , gate open)					
$T_C = 25^\circ\text{C}$	I_{DRM}	-	-	10	μA
$T_C = 110^\circ\text{C}$	I_{RRM}	-	-	500	
Peak on-state voltage ($I_{\text{TM}} = 5\text{A}$ peak, pulse width = 1 ms, duty cycle $\leq 2\%$)	V_{TM}	-	-	1.8	Volts
DC gate trigger current (continuous dc) ($V_D = 6\text{V}$, $R_L = 50\Omega$) MT2(+), G(+); MT2(-), G(-); MT2(+), G(-), $T_C = 25^\circ\text{C}$ ($V_D = 12\text{V}$, $R_L = 50\Omega$) MT2(+), G(+); MT2(-), G(-); MT2(+), G(-), $T_C = -40^\circ\text{C}$	I_{GT}	-	-	25	mA
DC gate trigger voltage (continuous dc) ($V_D = 12\text{V}$, $R_L = 50\Omega$) MT2(+), G(+); MT2(-), G(-); MT2(+), G(-), $T_C = 25^\circ\text{C}$ MT2(+), G(+); MT2(-), G(-); MT2(+), G(-), $T_C = -40^\circ\text{C}$ ($V_D = \text{rated } V_{\text{DRM}}$, all mode, $T_C = 110^\circ\text{C}$)	V_{GT}	-	-	2.0	Volts
		0.2	-	-	

Holding current $(V_D = 24V, R_L = 200\Omega, \text{gate open})$ $T_C = 25^\circ C$ $T_C = -40^\circ C$	I_H	-	-	50 100	mA
Latching current $(V_D = 24V)$ Trigger source: 5V, 50 Ω $MT2(+), G(+); MT2(-), G(-), T_C = 25^\circ C$ $MT2(+), G(-), T_C = 25^\circ C$ Trigger source: 10V, 50 Ω $MT2(+), G(+); MT2(-), G(-), T_C = -40^\circ C$ $MT2(+), G(-), T_C = -40^\circ C$	I_L	-	-	50 100 100 200	mA
Critical rate of rise of off-state voltage $(V_D = \text{Rated } V_{DRM}, \text{gate open}, T_C = 110^\circ C)$	dv/dt	-	15	-	V/ μs
Critical rate of rise of commutating voltage $(V_D = \text{Rated } V_{DRM}, I_{T(RMS)} = 3A, di/dt = 1.6A/ms, \text{gate open}, T_C = 65^\circ C)$	dv/dt	-	5	-	V/ μs

Note 1: Torque rating applies with use of compression washer. Mounting torque in excess of 6 in. lb. does not appreciably lower case-to-sink thermal resistance. Node lead and heatsink contact pad are common. Soldering temperatures shall not exceed +200°C.

MECHANICAL CHARACTERISTICS

Case	TO-126
Marking	Alpha-numeric
Polarity	Cathode is stud



	TO-126			
	Inches		Millimeters	
	Min	Max	Min	Max
A	0.425	0.435	10.80	11.050
B	0.295	0.305	7.490	7.750
C	0.095	0.105	2.410	2.670
D	0.020	0.026	0.510	0.660
F	0.115	0.125	2.920	3.180
G	0.091	0.097	2.310	2.460
H	0.050	0.095	1.270	2.410
J	0.015	0.025	0.380	0.640
K	0.595	0.655	15.110	16.640
M	3° TYP		3° TYP	
Q	0.148	0.158	3.760	4.010
R	0.045	0.055	1.140	1.400
S	0.025	0.035	0.640	0.890
U	0.145	0.155	3.680	3.940
V	0.040	-	1.020	-

SC136 SERIES

BIDIRECTIONAL TRIODE THYRISTORS

FIGURE 1 – RMS CURRENT DERATING

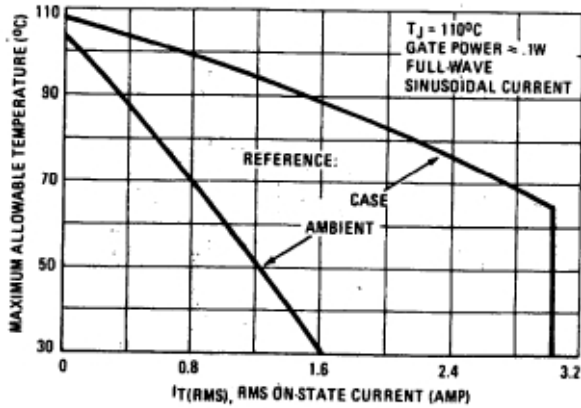


FIGURE 2 – MAXIMUM POWER DISSIPATION

